

ABSTRACT OF THE DISCLOSURE

A semiconductor integrated device has one signal processing IC and one MCU. A few terminals of the IC are connected to the corresponding terminals of the MCU. The  
5 terminals of the IC that are connected to the corresponding terminals of the MCU are disposed near each other. Similarly, the terminals of the MCU that are connected to the corresponding terminals of the IC are disposed near each other. Moreover, the IC and the MCU are mounted, on a  
10 substrate, in such a manner that the above-mentioned terminals of the IC and MCU face each other.